

## 欧盟 RoHS2.0 合规声明

### EU RoHS2.0 compliance statement

尊敬的各位客户;

Dear customers;

我司承诺供应的产品均符合欧盟 RoHS2.0 (2011/65/EU) 及 RoHS 指令 (2015/863/EU) 中有害物质的限制要求, 其中我司的铅超标符合 RoHS 指令中的豁免条款 7 (a) 与 7 (c) -V。Our company promises that all products supplied by our company are in accordance with the restriction requirements of hazardous substances in EU RoHS2.0 (2011/65/EU) and RoHS Directive (2015/863/EU), among which, our company's lead exceeds the standard and conforms to the exemption clause 7 (a) and 7 (c) -V in the RoHS directive.

7 (a): 高熔点型焊料中的铅, 如铅含量等于或大于 85%的铅基合金焊料。

7 (a): Lead in high melting point solders, such as lead-based alloys with a lead content of 85% or more.

7 (c) -V: 电气和电子元件中玻璃或玻璃基质化合物所含的铅, ①用于高压二极管玻璃珠及晶片玻璃层的保护与电绝缘。②用于陶瓷、金属和/或玻璃部件的密封。

7 (c) -V: Lead contained in glass or glass matrix compounds in electrical and electronic components. ①It is used for the protection and electrical insulation of the high-voltage diode glass beads and the wafer glass layers.②Used for sealing of ceramic, metallic, and/or glass components.

承诺单位: 江苏捷捷微电子股份有限公司

Commitment to the company: Jiangsu Jiejie Microelectronics Co., Ltd.

承诺日期: 2026.3.31

Commitment to date: Mar. 31, 2026

